

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	300	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	T _A = +25°C T _A = +70°C	I _D	0.25 0.20	A
Pulsed Drain Current (10µs pulse, duty cycle ≦1%)			I _{DM}	2	А
Maximum Body Diode Continuous Current (Note 6)			Is	0.8	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Tatal Power Dissinction	(Note 5)	р	0.31	W
Total Power Dissipation	(Note 6)	P _D	0.47	
Thermal Decistance Junction to Ambient	(Note 5)		377	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{ extsf{ heta}JA}$	255	
Thermal Resistance, Junction to Case	(Note 6)	$R_{ ext{ heta}JC}$	81	
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to 150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•	·	
Drain-Source Breakdown Voltage	BV _{DSS}	300	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μA	$V_{DS} = 240V, V_{GS} = 0V$	
Gate-Body Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1		3	V	V_{DS} = V_{GS} , I_D = 250 μ A	
Static Drain-Source On-Resistance		_	2.1	4	Ω	V _{GS} = 10V, I _D = 0.3A	
	Rds(on)	—	2.1	4		V _{GS} = 4.5V, I _D = 0.2A	
		_	3.8	6		V _{GS} = 2.7V, I _D = 0.1A	
Diode Forward Voltage	V _{SD}	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 0.3A$	
DYNAMIC CHARACTERISTICS (Note 8)					_		
Input Capacitance	C _{iss}	_	187.3			V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	C _{oss}	_	11.7		pF		
Reverse Transfer Capacitance	C _{rss}	_	8.7				
Total Gate Charge	Qg	_	7.6	_			
Gate-Source Charge	Q _{gs}	_	0.5	_	nC	V _{DS} = 192V, V _{GS} = 10V, I _D = 0.5A	
Gate-Drain Charge	Q _{gd}	_	3.3	_			
Turn-On Delay Time	t _{D(on)}	_	4.9			V _{DS} = 60V, R _L =200Ω V _{GS} = 10V, R _G = 25Ω	
Turn-On Rise Time	tr	_	4.7	_	nS		
Turn-Off Delay Time	t _{D(off)}	_	25.8	_	115		
Turn-Off Fall Time	t _f		17.5]		

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout

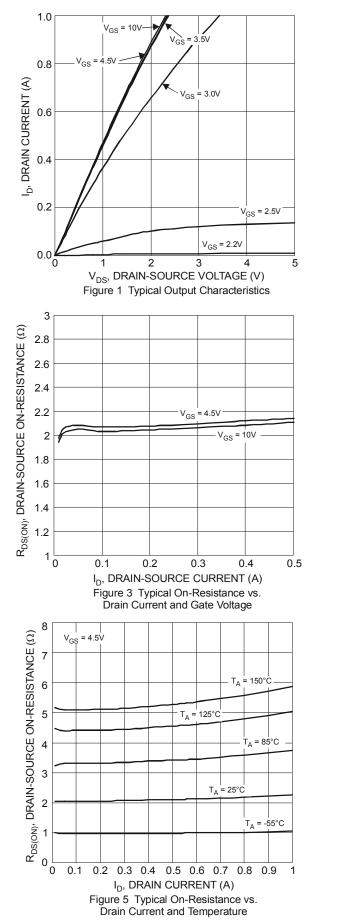
7 .Short duration pulse test used to minimize self-heating effect.

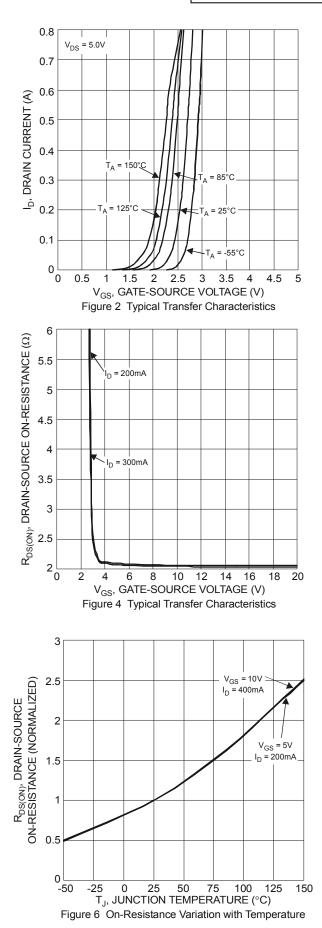
8. Guaranteed by design. Not subject to production testing.

Notes:



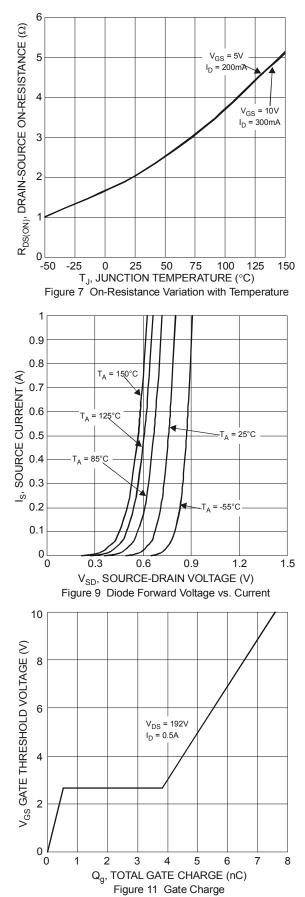


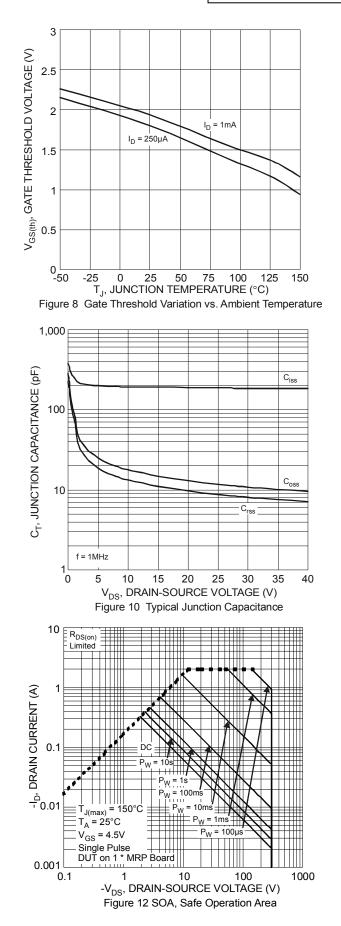






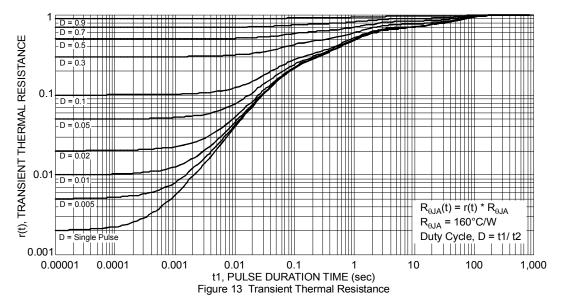






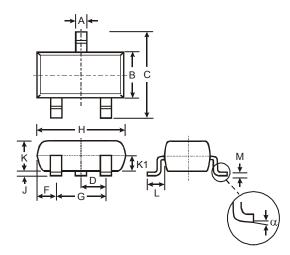
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Package Outline Dimensions

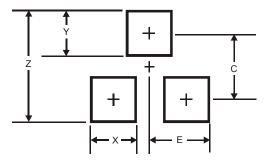
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
в	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
κ	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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